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Bachelor Thesis in Physics submitted by

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# Calibration of BrainScaleS PowerIt Subsystem and Regulating a BrainScaleS Power Supply

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#### **Abstract**

Accurate measurements and voltage supply is a integral part for any system to work perfectly. In the Human Brain Project framework this thesis will provide a calibration of the BrainScaleS Powerlt Subsystem as well as a regulation mechanism for a BrainScales power supply.

It will give insight into the internal workings of the Powerlt. Its circuitry will be examined and calibrated, for use in BrainScaleS' monitoring. And a method for regulating one of its power Supplies will be implemented, based on observations done with an experimental setup of a in BrainScales deployed Wafer System.

This thesis also contains the changes done to the Powerlt Firmware while working on these Problems. The main focus layed on a new interfacing protocol. It can now be used for accessing the calibration and regulation parameters as well as their respective measured values .

#### Zusammenfassung

Das akkurate messen von und versorgen mit Spannungen ist ein integraler Teil jedweden elektrischen Systems, sodass diese reibungslos funktioniert. Innerhalb des Bereiches des Human Brain Projektes, liefert diese Arbeit die Kalibration des BrainScaleS Teilsystems Powerlt, sowie die Regulierung einer Spannungsversorgung des BrainScaleS.

Diese Arbeit verschafft einen Einblick in den internen Aufbauu des Powerlt, dabei werden dessen Schaltungen untersucht und kalibriert, sodass diese in der Systemüberwachung nutzbar sind. Ausserdem lifert diese Arbeit eine Methode der Regulation für eine der Sapnnungsversorgungen. Diese basiert vor allem aif den Beobachtungen mittels eines experimentellen aufbaus eines in BrainScaleS genutzten Wafer Systems.

Zusätzlich enthalten sind die Änderungen, die an der Powerlt Firmware vorgenommen worden sind. Dabei liegt der Fakus auf einem neuen Protokoll zur kommunikation, welches dafür genutzt werden kann die Parameter und Werte der Kalibration und Regulation auszulesen oder zu setzen.

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## 1 Introduction

## 1.1 The BrainScale System

The BrainScale Wafer System [1], developed and used in the electronic visions group at Heidelberg University is a neuromorphic hardware implementation.

For this thesis the following core components are of importance:

- mixed-signal ASICs, named HICANNs, structured in packs of 8 into reticles
- Control Units for Reticles, short CURE boards
- Analog Breakout boards, AnaB for short
- and power supply, called Powerlt.

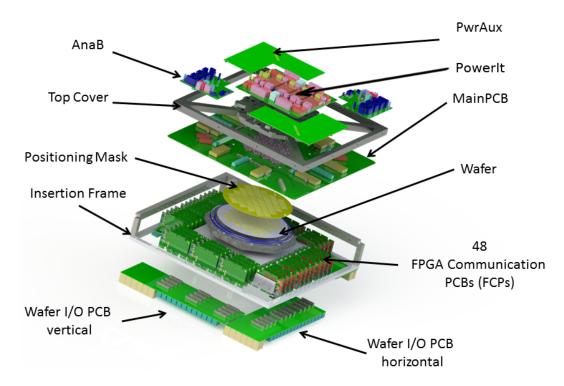


Figure 1.1: The BrainScaleS wafer-scale hardware system, marked are the main components comprising a single wafer system. [2]

#### 1.2 About the PowerIt Subsystem

The main subject of this thesis is the Powerlt board (Figure 1.2). It functions as power supply inside of the WaferScale system (Figure 1.1). In which it is providing the wafer with  $1.8\,\text{V}$  and the FPGAs with  $9.6\,\text{V}$ . Its maximum rated power draw is  $2\,\text{kW}$ . [3]

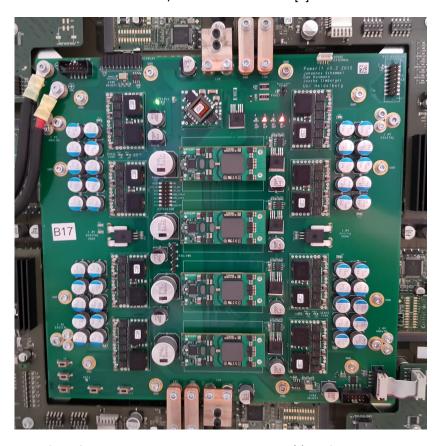


Figure 1.2: Powerlt board, top view, receiving  $48\,V$  as input ( ) and outputting  $9.6\,V$  ( ) as well as  $1.8\,V$  (analog: ; digital: )

The brain of these Powerlt boards is a STM32 Chip<sup>1</sup> which runs a custom firmware based on ChibiOS [5]. The Powerlt, while providing 9.6 V and 1.8 V, also is able to measure the following values:

- input voltage and current
- 1.8 V output voltage and current
- and the 9.6 V output Voltage

which can then be used inside the firmware.

While the input voltage is given from outside it is still changeable if the power supply is able to vary its output voltage. Additionally the 9.6 V are a set voltage obtained by the power supply modules<sup>2</sup>, which divide the input voltage by 5. Lastly the 1.8 V output voltage is variable.

<sup>&</sup>lt;sup>1</sup>STM32F405RGT [4]

<sup>&</sup>lt;sup>2</sup>5:1 Bus converter IB0xxE096T48xx, 500W each

#### 1.3 Contents in Detail

The first goal was to be able to change the calibration parameters. While this can be done at compiletime, these changes are board specific. Therefore they either need to be changed, before compiling, which would require a compilation per board. Or else the need to be able to change during runtime. For mainly maintainability reasons the second way was choosen.

But these calibration changes could not be transferred to the Powerlt using the old communication protokol, referred to as PItCOMM version 1. A updated protocol was needed and it had to be able to accept not only the beforementioned values, but also any additional information or configuration.

And while at it the protocol, now PItCOMM version 2, was made to be somewhat compliant with the SMBus specifications. This was accomplished with a virtual memory map, which maps every parameter to a specific location in a virtual memeory. In this memory, any value which needed to be accessible, be it measurement, calibration or static board information, is mapped (see Figure 4.1).

Whith this as foundation, the Powerlt could be calibrated. And the calibration parameters were be stored in a database. The Calibration characterizes the voltage measuring circuit, whose voltages are either coming into or leaving the Powerlt.

Lastly, with a now calibrated board, a power supplys behavior was observed and corrected for, with a regulation mechanism.

## 2 Theory

This chapter will be discussing the fundamental principles used in the experiments. These will contain simplified circuits and their respective equations as well as component behavior as specified in their respective datasheets by their manufacturer

#### 2.1 Hardware Component Behavior

Before discussing the experimental results it needs to be clear what circuitry is used in these experiments and what behavior we expect. Keeping in mind, that these are theoretical values and will most likely not be exactly the same as those found in actual hardware, as all values given will always be within some error.

Each of the three voltage regimes that will be observed on the Powerlt board, 48 V, 9.6 V and 1.8 V, has a voltage- and in the cases of 48 V and 1.8 V also a current-measurement circuit. Additionally there is a temperature sensor built into the STM32 chip.

#### 2.1.1 ADC Calibration

The measurements will be done by the STM32-Chip, which uses 12bit ADCs. A single ADC will be switching between all connected pins. This Behavior can be problematic in regards to measuring accurately. The timing used to measure a single pin can be programmatically set from 3 up to 480 clock ticks<sup>1</sup>

#### 2.1.2 48V Input Voltage

The circuits for measuring input voltage and current are the most complex. For voltage measurement the circuit needs to

- divide our input voltage into a usable potential range
- decouple the input (48 V) from signal potential (3.3 V)
- and amplify the voltage, to be in the STM32-Chips Voltage range of up to 3.3 V.

The already implemented cicuit can be seen in Figure 2.1.

It consists of a 1:240 voltage divider, a full differential isolation amplifier taking in the roughly 200 mV (nominal voltage range), and amplifying it by a factor of 8 ( $r_{\rm diffOpAmp}$  [6]). It is also decoupling the input and output voltages, so our 48 V and 3.3 V circuit parts are electrically

<sup>&</sup>lt;sup>1</sup>this clock is the internal adc clock, with a frequency of 159 Hz

insulated. The remaining operational amplifier provides difference to single ended conversion with an amplification or  $1.1\ (r_{\rm OpAmp})$ 

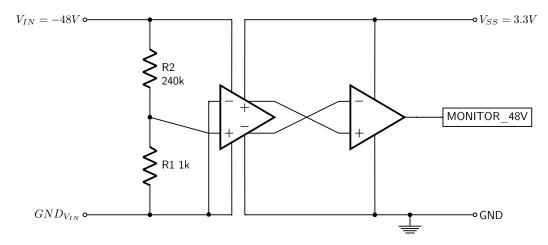


Figure 2.1: Circuit for measuring the 48 V input voltage, consisting of input potential (left), two resistors as voltage divider, one fully differential isolation amplifier (left), one operational Amplifier (right), output voltage as well as the connection to the STM32-Chips input pin (right)

This circuit results in the following equation for calculating the input voltage from a pin voltage:

$$V_{48V \text{ in}} \cdot \frac{R_1}{R_1 + R_2} \cdot r_{\text{diffOpAmp}} \cdot r_{\text{OpAmp}} = V_{\text{MONITOR\_48V}}$$

$$\Leftrightarrow \frac{V_{\text{MONITOR\_48V}}}{r_{\text{diffOpAmp}} \cdot r_{\text{OpAmp}}} \cdot \frac{R_1 + R_2}{R_1} = V_{48V \text{ in}}$$
(2.1)

and the extremes, when assuming  $(48.0 \pm 4.8) \, \text{V}$  are

$$V_{\text{MONITOR\_48V, min}} = 43.2 \,\text{V} \cdot \frac{1}{240+1} \cdot 8 \cdot 1.1 = 1.5774 \,\text{V}$$
 (2.2)

$$V_{\text{MONITOR\_48V, max}} = 52.8 \,\text{V} \cdot \frac{1}{240+1} \cdot 8 \cdot 1.1 = 1.9280 \,\text{V}$$
 (2.3)

#### 2.1.3 48 V Input Current

The circuit has to satisfy the following constraints:

- use a shunt resistor, with minimal heat dissipation
- while still providing a good resolution within the STM32-Chips specifications

To accomplish that, the circuit is measuring the voltage over a  $500\,\mu\Omega$  shunt Resistor, while a current is flowing. By Ohms Law that results in a linear proportionality between current an the obtained voltage. Which is then decoupled and amplified by a factor of 8, as well as converted from a difference to single ended voltage, with a amplification factor of 1.1.

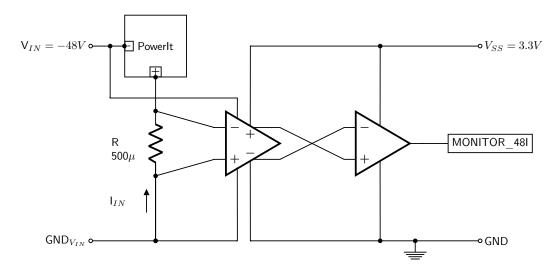


Figure 2.2: Circuit for measuring the 48 V input current, consisting of the powerit Input circuit, one shunt-resistor, one full diff isolating Amplifier, one operational amplifier, output potential, as well as the connection to the STM32-Chips input pin

Here the same amplifiers as in subsection 2.1.2 is used and so we can apply the following equation for our input current:

$$I_{48V \text{ IN}} \cdot R_{\text{shunt}} \cdot r_{\text{diffOpAmp}} \cdot r_{\text{OpAmp}} = V_{48I \text{ pin}}$$

$$\Leftrightarrow \frac{V_{48I \text{ pin}}}{R_{\text{shunt}}} \cdot \frac{1}{r_{\text{diffOpAmp}} \cdot r_{\text{OpAmp}}} = I_{48V \text{ IN}}$$
(2.4)

The current range is from  $0\,A$  up to  $41.7\,A$  (=  $2\,kW$  /  $48\,V$ )and gives a resulting observable voltage range from  $0\,V$  to:

$$41.7 \text{ A} \cdot 500 \,\mu\Omega \cdot 8 \cdot 1.1 = 0.1833 \,\text{V}$$
 (2.5)

#### 2.1.4 9.6V Output Voltage

The measurement of 9.6 V is quite simpler. This Circuit consists of a 1:3 Voltage Divider.

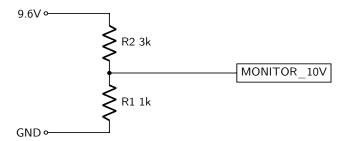


Figure 2.3: Circuit for measuring 9.6V output voltage. Consisting of a voltage divider with 1:4 ratio, input voltage (left) and output voltage (right)

To describe that circuit the following equation can be used:

$$\frac{V_{9.6V \text{ IN}} \cdot R_1}{R_1 + R_2} = V_{\text{MONITOR}\_10V}$$
 (2.6)

$$\Leftrightarrow \frac{V_{\text{MONITOR}}_{-10V}}{R_1} \cdot (R_1 + R_2) = V_{9.6V \text{ IN}}$$
(2.7)

#### 2.1.5 1.8V Output Voltage

To measure this Voltage the output is directly connected to a pin on the STM32-Chip.

But until now the voltages and current could only be measured, now the mechanism for setting a resulting voltage at the  $1.8\,\text{V}$  terminals is known. The circuit for generating  $1.8\,\text{V}$  can be seen in Figure 2.4. It consists of a power module and a resulting resistance between two pins, defined by  $R_{\text{series}}$ ,  $R_{\text{parallel}}$  and  $R_{\text{pot}}$ . The resistances job is to set the output to a given voltage of around  $1.8\,\text{V}$ . That voltage can be varied based on  $R_{\text{pot}}$ , because this resistance is set via a digital potentiometer<sup>2</sup>.

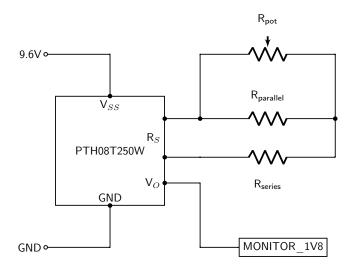


Figure 2.4: 1.8V supply circuit, featuring a DC-DC Converter, a resistor chain, supply voltage (left) and resulting voltage (right)

The in Figure 2.4 used 1.8 V converter has a characteristic formula [8], and the in this circuit used potentiometer is a linear  $10 \,\mathrm{k}\Omega$  Reheostat.

Therefore equations 2.8, 2.9 and 2.10 can describe the circuit.

$$\begin{split} R_{\mathsf{potentiometer}} = & P_{\mathsf{val}} \frac{10 \, \mathsf{k}\Omega}{256} \\ R_{\mathsf{SET}} = & \left(\frac{1}{R_{\mathsf{potentiometer}}} + \frac{1}{R_{\mathsf{parallel}}}\right)^{-1} + R_{\mathsf{series}} \\ = & \frac{R_{\mathsf{potentiometer}} \cdot R_{\mathsf{parallel}}}{R_{\mathsf{potentiometer}} + R_{\mathsf{parallel}}} + R_{\mathsf{series}} \\ V_{\mathsf{MONITOR}\_1V8} = & \frac{30.1 \, \mathsf{k}\Omega}{R_{\mathsf{SET}} + 6.49 \, \mathsf{k}\Omega} \cdot 0.7 \, \mathsf{V} + 0.7 \, \mathsf{V} \end{split} \tag{2.8}$$

<sup>&</sup>lt;sup>2</sup>MCP4152 digital Rheostat [7]

Visualizing the Equation 2.9 results in Figure 2.4, in which the limits of this circuit are visible.

$$V_{\text{MONITOR 1V8, min}} = 1.549 \,\text{V}$$
 (2.11)

$$V_{\text{MONITOR 1V8, max}} = 2.022 \,\text{V}$$
 (2.12)

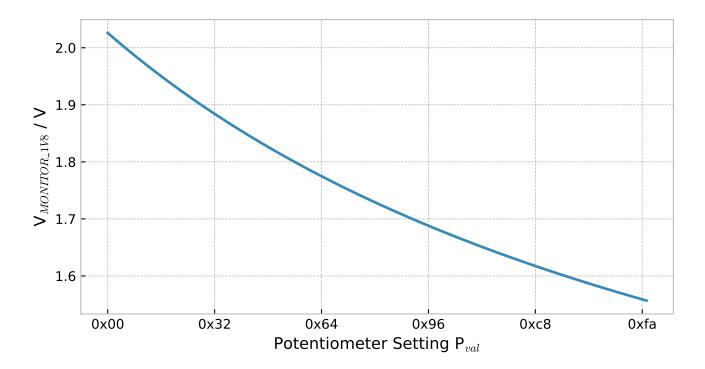


Figure 2.5: Expected behavior of 1.8V output voltage vs potentiometer setting

#### 2.1.6 1.8V Output Current

The circuit for measuring the outgoing current over 1.8V, consists of a current sensing IC, which is Hall sensor based. Each connection (digital and analog) has this IC in series to its load.

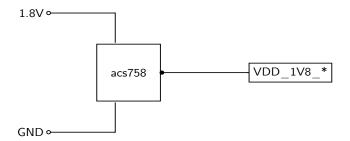


Figure 2.6: 1.8V current sensing circuit, featuring a acs758, hall sensor based current sensing IC, input voltage (left) and output voltage (right)

The IC is rated for a maximum constant current draw of 100A, and features the following behavior:

$$I_{1.8V, in} \cdot 0.004 \, \text{V A}^{-1} + 0.12 \, \text{V} = V_{\text{MONITOR 118}}$$
 (2.13)

By applying the limits of 0 A and 100 A, the following voltage range can be observed:

$$0 A \cdot 0.004 V A^{-1} + 0.12 V = 0.12 V$$
 (2.14)

$$100 A \cdot 0.004 V A^{-1} + 0.12 V = 0.52 V$$
 (2.15)

### 2.2 1.8V Output Regulation

The method for regulating the 1.8 V output voltage consists of two parts.

First the voltage, wanted at the output terminal and second the corresponding potentiometer setting to use for that voltage On the other hand, to calculate the voltage to output, it is necessary to classify the connections between the Powerlts output terminals and reticles.

#### 2.2.1 Potentiometer Mapping

Combining Equations 2.8, 2.9, and 2.10, we gather Equation 2.16. This equation maps a given output voltage to a corresponding Potentiometer Setting (reverse to Figure 2.5).

$$P_{\text{val}} = \frac{R_{\text{par}} \left[ \left( \frac{0.7V \cdot 30.1k\Omega}{V_O - 0.7V} - 6.49k\Omega \right) - R_{\text{ser}} \right]}{R_{\text{par}} + \left( \frac{0.7V \cdot 30.1k\Omega}{V_O - 0.7V} - 6.49k\Omega \right) - R_{\text{ser}}} \cdot \frac{256}{10k\Omega}$$
(2.16)

This mapping will be converted into a lookup table before the Powerlt firmware is initiated.

#### 2.2.2 Power Wafer

To test the 1.8 V regulation the so called PowerWafer is going to be used. It can be controlled similar to a in BrainScaleS used, functional, Wafer module. But it is fundamentally different, as it cannot be used for any neuromorphic computations, but only to test for voltages and currents. Its internals are ohmic resistors, which provide a maximum power draw per reticle of what is possible inside a usable wafer module.

			0	1	2			
		3	4	5	6	7		
	8	9	10	11	12	13	14	
15	16	17	18	19	20	21	22	23
24	25	26	27	28	29	30	31	32
	33	34	35	36	37	38	39	
,		40	41	42	43	44		
			45	46	47		•	
		15 16 24 25	8     9       15     16     17       24     25     26       33     34	3 4 8 9 10 15 16 17 18 24 25 26 27 33 34 35 40 41	3 4 5 8 9 10 11 15 16 17 18 19 24 25 26 27 28 33 34 35 36 40 41 42	3     4     5     6       8     9     10     11     12       15     16     17     18     19     20       24     25     26     27     28     29       33     34     35     36     37       40     41     42     43	3     4     5     6     7       8     9     10     11     12     13       15     16     17     18     19     20     21       24     25     26     27     28     29     30       33     34     35     36     37     38       40     41     42     43     44	3     4     5     6     7       8     9     10     11     12     13     14       15     16     17     18     19     20     21     22       24     25     26     27     28     29     30     31       33     34     35     36     37     38     39       40     41     42     43     44

Figure 2.7: Reticle diagram of a wafer in BrainScaleS. All 48 Reticles are shown

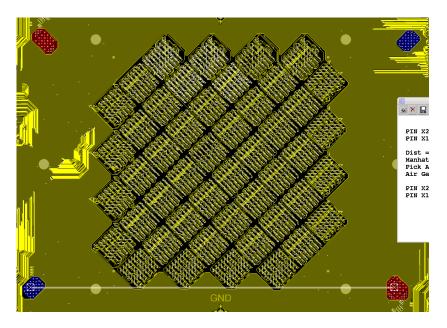


Figure 2.8: Part of the main pcb on which a wafer is placed, visible are the 48 Reticles and two terminals each for 1.8V Digital (blue) and Analog (red), which correspond to the output terminals on a Powerlt, a reticles dimensions are 2.0077 cm by 2.0077 cm

It has the same layout as its system counterparts and each of the 48 reticles can be accessed, digitally as well as electrically. Each reticle is connected to its corresponding CURE board. Those can read voltages of each reticle, but not at the same position as an AnaB. They read right before  $R_1$  in Figure 2.9.

Another specialization of the PowerWafer is, that all reticles analog and digital 1.8 V lines are connected directly to pins on the analog readout boards [9]. There it is possible to measure a voltage, which is the one after the load resistors in Figure 2.9

#### 2.2.3 Simple Wafer Resistance Model (SWRM)

To describe the reistances on such a wafer module, a model is needed. For that the circuit in Figure 2.9 can be used. This naive model will be referenced as SWRM (Simple Wafer Resistance Model) from here.

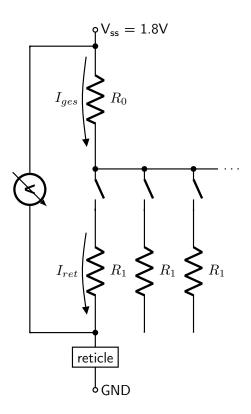


Figure 2.9: model of the to measure resistances and their currents,  $R_0$  describes the resistance of a connection between the Powerlt Output and up to the FET (depicted as switch), while  $R_1$  is a Resistance between FET and Reticles. The measurement is done between Output Terminals on the Powerlt and pins on a Analog readout board

The SWRM circuit consists of two fixed resistance values and their respective currents as approximations of a real world system. It assumes that the connection to the nearest voltage connector is equal (electrically) for all reticles.

inside the code used for Regulation, Equation 2.16 will be used to create a lookup table, while Equation 2.20 will be used at runtime, for which Equation 2.18 and 2.19 are needed. In the SWRM, the current flowing through  $R_1$  will be either 0 or a constant current  $I_{\text{ret}}$ . And the current through  $R_0$  will change depending on the number of reticles that are powered  $n_{\text{ret}}$ 

$$I_{ges} = n_{ret} \cdot I_{ret} \tag{2.17}$$

Therefore the voltage drop  $V_{\rm dip}$  as measured by a voltmeter (see Figure 2.9) can be described with Equation 2.18

$$\begin{split} V_{\mathsf{dip}} &= V_{R_1} + V_{R_0} \\ &= R_1 \cdot I_{\mathsf{ret}} + R_0 \cdot I_{\mathsf{ges}} \\ &= I_{\mathsf{ret}} \cdot (R_1 + R_0 \cdot n_{\mathsf{ret}}) \end{split} \tag{2.18}$$

$$V_{\mathsf{dip}} = V_O - V_{\mathsf{off}} \tag{2.19}$$

$$\Rightarrow V_O = I_{\mathsf{ret}} \cdot (R_1 + R_0 \cdot n_{\mathsf{ret}}) + V_{\mathsf{off}} \tag{2.20}$$

## 3 Experiments

Now that the theoretical model is complete, experiments can be done to start checking that model and get results to use for in system components.

#### 3.1 Experimental Setup

But before diving into the measurements ashort tour of both experimental setups. THe first setup was used during the calibration phase, while the secon setup was used for creating the regulation model.

#### 3.1.1 Part 1

To calibrate a Powerit a setup is required, that can sweep the input voltage, as well as draw different current from the Powerlt (see Figure 3.1). For that a setup with a bench power supply an electronic load and an external voltmeter are used. Additionally a STM32-Discovery board and a RaspberryPi microcomputer were connected to flash new firmware onto the Powerlt.

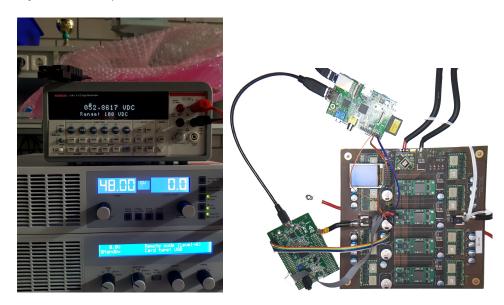


Figure 3.1: Left: Keithley K2100 voltmeter (top), PS9080 bench power supply (middle) and EL9000 electronic load (bottom; Right: Powerlt with connected STM32-Discovery board (left), and Raspberry PI (top). as well as power supply connection (cables at top ow PIT)

To now calibrate the board the bench supply could be controlled, to sweep through a voltage range, or in a similar fashio the electronic load could sweep through different current draw scenarios. This setup includes cable connections to voltmeter, power supply and load as to be able to control them with a piece of software.

#### 3.1.2 Part 2

To obtain the required measurements for creating a regulation model the second setup was used.

#### 3.2 Characterization

The first experiments to run are the characterization of hardware behavior. These will then result in a Powerlt Calibration, which later then can be used as basis for creating a regulation method.

#### 3.2.1 Sampling Time

First up was selecting an optimal number of cycles for which the adc will probe a to it connected pin, like described in subsection 2.1.1.

In this case the uncalibrated measurement of input voltage was taken as example, and repeated with each of the possible 8 settings.

To be able to compare a reference voltage measurement was taken with an external Voltmeter<sup>1</sup>. The resulting errors, from a set Voltage, can be seen in figures 3.2

Figure 3.2 contains the absolute error of the measured voltage compared to the theoretical, set input voltages. therefore the reference measurements (yellow), taken with an external Voltmeter, are not at 0. Also shown are the calculated gain errors, in case of all 8 settings.

Important to note is the relative error in only the 0th case, here the <code>cycleTime-Setting</code> was set to 0 and therefore the smallest available sampling time of 3 Ticks. This excludes 0 a possible value to use. All other measurements are within error margin of each other, and because a smaller time frame is preferred, the best value to use is 1, resulting in a measure time of 15 Ticks.

#### 3.2.2 Voltages

Now that a sample time is chosen, it is possible to proceed with the voltage calibration measurements. Note, that measurements are expected to be less accurate, the more components are contained in their respective measurement circuit. Because small errors will accumulate and in e.g. the case of 48V's be amplified by a factor of 8.

<sup>1</sup> Keithley	K2100		

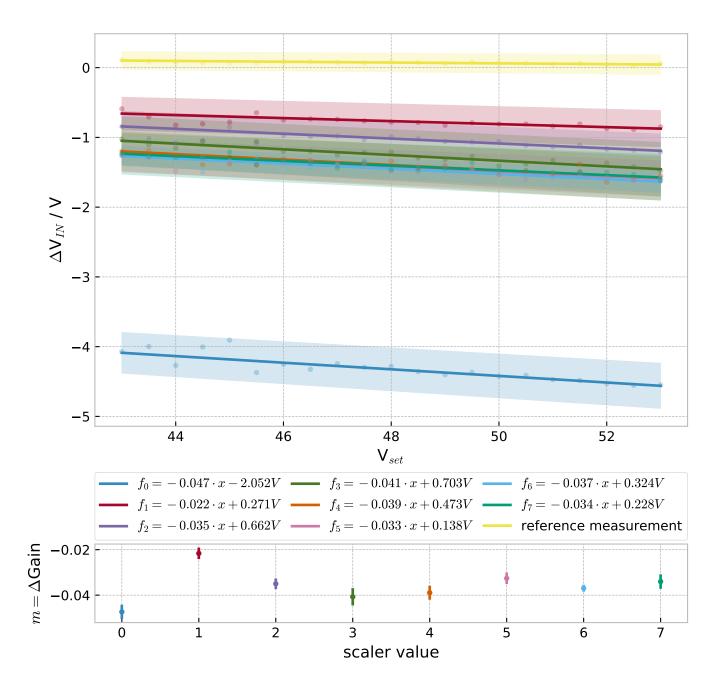


Figure 3.2: up: input difference from set voltage vs set voltage for different possible scaler values; down: gain error of the linear fitted curves vs set scaler value (May 29th 2018,  $\approx$ 32°C)

#### 48V Input

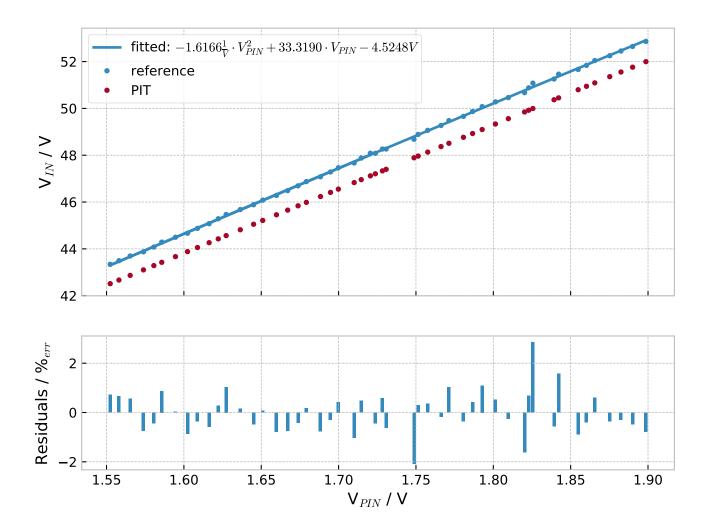


Figure 3.3: Calibration of input voltage, plotted are a external measurement and internal values, vs the recalculated pin voltage based on the internal value and used default function (default coefficients see Figure 4.2)

When looking at calibrating the input voltage (Figure 3.3), we can clearly see a relatively constant offset of  $\approx 1$ V. In Figure 3.3 a polynomial fit of 2nd degree<sup>2</sup> is done and its coefficients extracted (Figure 4.2.1, line 9). These coefficients not only show an offset, but also some deviation in the

<sup>&</sup>lt;sup>2</sup>A Fit of second degree will be used in the complete calibration process

incline and curve from the default values.

#### 9.6V Output

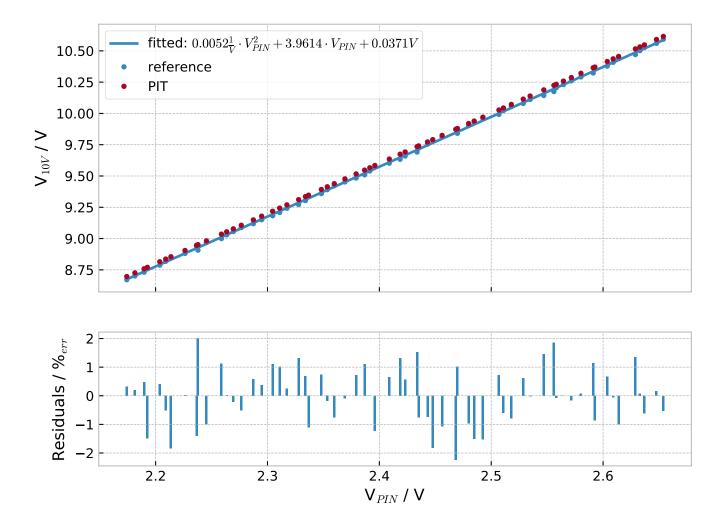


Figure 3.4: Calibration of 9.6V output Voltage, plotted are an external measurement and internal values vs the recalculated pin voltage based on the default coefficients (Figure 4.2)

The 9.6V Calibration, in contrast, shows only a slight deviation of the internal values and the reference measurement, which results in a list of coefficients (Figure 3.6, line 7), very similar to those set in the theoretical defaults.

This small difference is explained by the simple voltage division used as our circuitry, and no amplification, as for the input voltage circuit.

#### 1.8V Output

The last Voltage to calibrate is divided into two domains, one for supplying the analog circuitry inside the wafer system, and one for the digital side. Each deliver between 1.5 and 2.022V and each

is settable by its own circuit (both as in Figure 2.4).

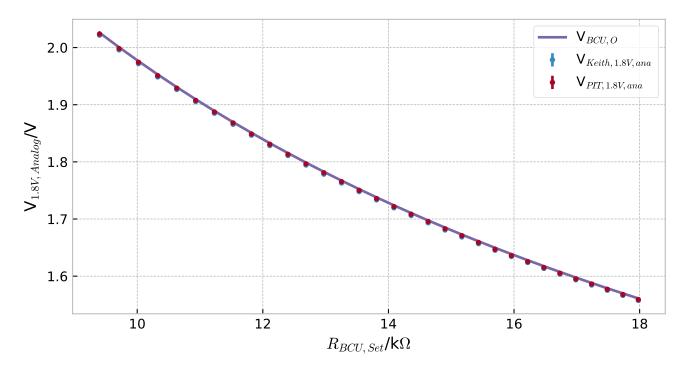


Figure 3.5: Calibration: analog 1.8V Output voltage, plotted are external measurement and internal values vs set resistance at the BCU Voltage Module.

Visualized in Figure 3.5 is the analog domains calibration, showing nearly no difference in board and reference measurements. Mostly due to direct connection between created voltage and the STM-Chips pin.

#### 3.2.3 Currents

With now calibrated Voltages, the next step is to measure the behavior of the measuring circuits. Note that the 9.6V Output does in fact not have a include circuit for measuring its current draw, and that this number will be obtainable from all other (calibrated) measurements.

## 48V Input

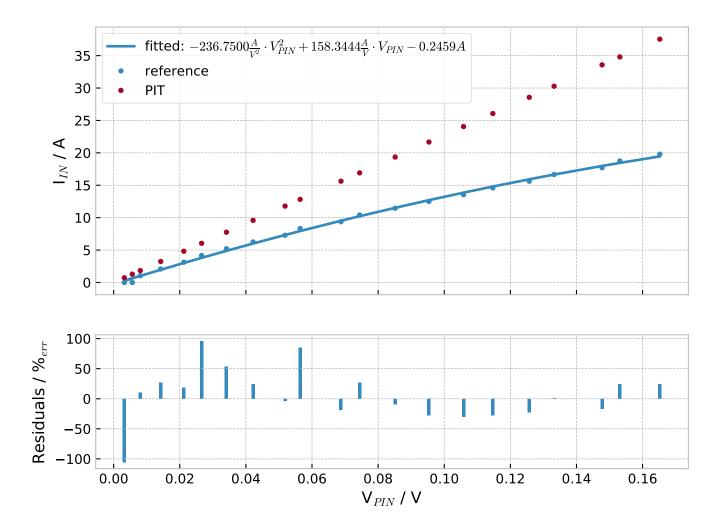


Figure 3.6: Calibration of input current ADCs 21.06.2018

#### 1.8V Output

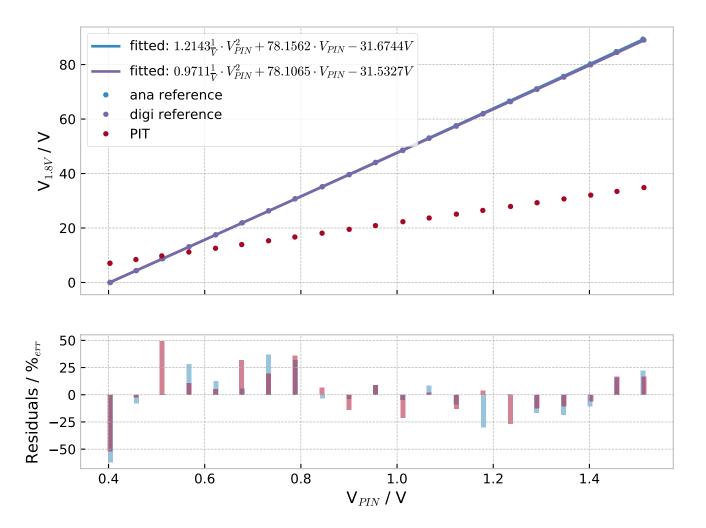


Figure 3.7: Pre Calibration Measurement of Output Current at the 1.8V Analog and Digital Terminal (2.7.2018)

## 3.3 1.8V Regulation

As Described beforehand the Output Voltages for both analog and digital can be adjusted to some degree and therefore we can compensate for the dropoff occurring between Powerlt Output Terminals and Reticles.

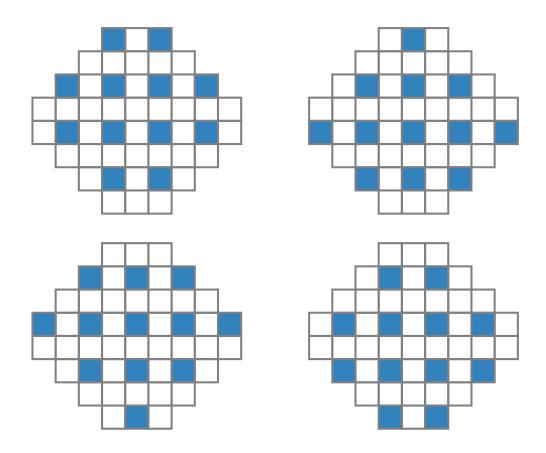


Figure 3.8: Used regular patterns for current tests on PowerWafer

#### 3.3.1 Characterization of Dropoff

Wanting to observe and characterize the voltage drop, first the connections between Powerlt and Reticles can be measured with the in Figure 2.9 described connections, which in actuality are the PowerlT Terminal and corresponding analog readout pin on a Analog readout board.

To use the PowerWafer for testing one of the patterns in Figure 3.8 will be used, each pattern has a approximate current draw of 120A and will distribute heat and draw per terminal evenly.

In Figure 3.9 a single reticles (40) Voltage Dip for different Current Draws is visualized. A relatively linear trend and residuals of a trigonometric behavior can be observed (most likely the result of the inaccurately measurable current draw, which here is done inside the Powerlt).

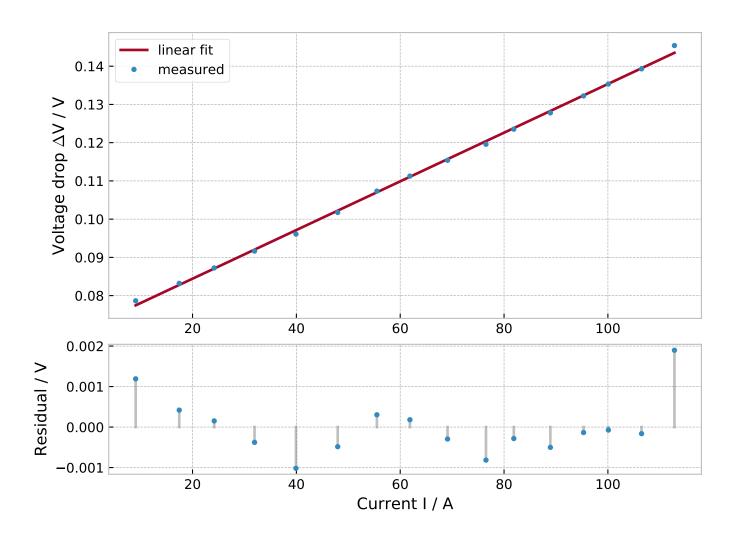


Figure 3.9: Voltage dip observed between Powerlt and HICANN, each point represents a state after enabling additional Reticles on the PowerWafer (right upper wafer in Figure 3.8)

Here a Voltage Drop vs. Current draw of the wafer shows a linear behavior and therefore can be regulated on basis of the current measurement done by on board Measurement circuit.

#### 3.3.2 Numerical-Correction (Regulation)

The initial idea, to approach the correction of this dropoff is a Numerical: the SWRM (subsection 2.2.3) and its corresponding Equations can be applied here. Equation 2.16, which maps the measured output current to a corresponding potentiometer setting, requires the Dropoff to be linear, which was observed.

To apply this approach, two assumptions need to be made:

- all reticles have the same current draw (already not accurate, see Figure 3.9)
- all reticles experience the same Voltage Dip (as observed for reticle 40)

and the following four values are required, before a regulation can be attempted:

- $\bullet$   $I_{ret}$ , the current draw of a single reticle,
- $R_0$ , the resistance between Powerlt and FET,
- ullet  $R_1$ , the resistance of a single Reticle
- ullet  $V_{off}$ , the wanted Voltage at a Reticle

To get a representative value of  $I_{ret}$  for use in the SWRM, the mean of all reticles current draw was taken (Figure 3.10):

$$I_{\rm ret,mean,corr} = (9.9089 \pm 0.6049) \, A$$
 (3.1)

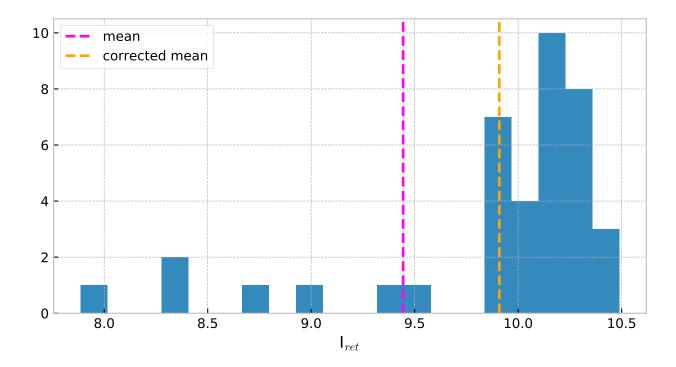


Figure 3.10: Distribution of analog current draw for all reticles on the PowerWafer (which were possible to measure  $\rightarrow$  section 3.4)

The Figure 3.10 was obtained by measuring the increase in current draw for each reticle, for each of the 4 patterns (Figure 3.8).

To obtain  $R_0$ , the pattern in Figure 3.11 was used to take measurements for both the Neighborhood as well as the Farthest Reticles.

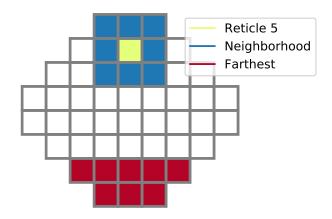


Figure 3.11: Reticles used to determine correlation between distance and Voltage Drop

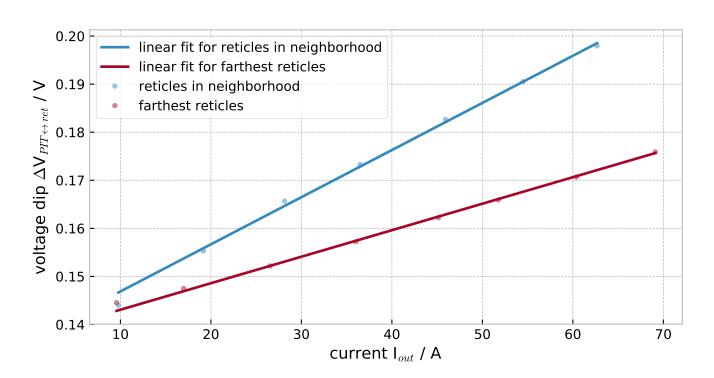


Figure 3.12: Voltage Dip vs current for both Reticles in direct neighborhood and farthest possible Reticles

From Figure 3.12 it is possible to see that the distance between reticles that are used gives different behavior of the Voltage Dip. Both Inclines happen to be the extreme cases, while either being completely uncorrelated, the case for farthest Reticles, or being directly correlated by their distance, here observable for the neighboring Reticles.

Therefore we obtain two values for  $R_0$ :

$$R_{0,\text{neighbor}} = (7.1278 \pm 0.1567) \,\mathrm{m}\Omega$$
 (3.2)

$$R_{0.\text{farthest}} = (4.0079 \pm 0.0537) \,\text{m}\Omega$$
 (3.3)

from the same measurement it is also possible to extract  $R_1$  by extrapolating to 0, which results in:

$$R_{1,\text{neighbor}} = (14.1708 \pm 0.1779) \,\mathrm{m}\Omega$$
 (3.4)

$$R_{1.\text{farthest}} = (14.2218 \pm 0.1503) \,\mathrm{m}\Omega$$
 (3.5)

here the values obtained are within error margin of each other.

So applying these Values, the following behavior for regulation can be visualized:

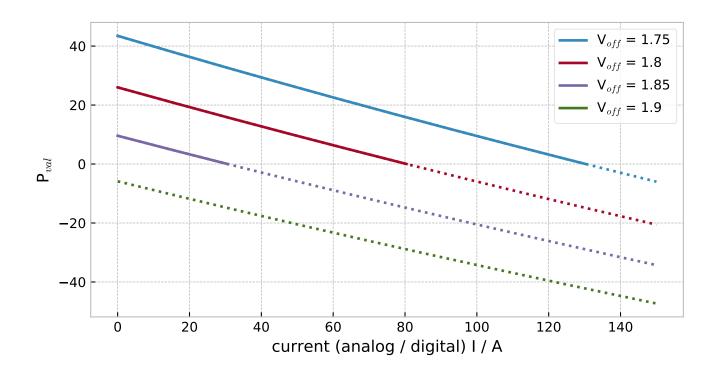


Figure 3.13: possible  $P_{val}$  curves after SWRM, dotted lines represent not achievable values

The in Figure 3.13 visualized values show the theoretical  $P_{val}$  for the corresponding Current, while all dotted parts depict the values which would be needed to achieve full correction at the Reticle level. Note that the 1.8V regulation, should fail at about 80A of current draw.

Now that the SWRM is applicable, what about the DWRM, which removes the assumption of a equal Voltage Dip per Reticle, applying an offset to the initially observed Voltage of each Reticle.

To account for that, the Voltage Dip per Reticle, in a single Reticle power state, was observed:

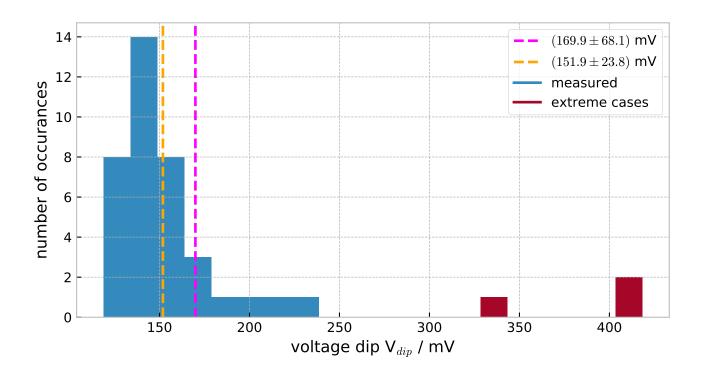


Figure 3.14: initially observed Voltage Dip, Red values are ignored for corrected mean

and a mean of:

$$V_{\rm dip,mean,corrected} = (151.8811 \pm 23.8138) \, {\rm mV}$$
 (3.6)

can be observed.

Figure 3.15 shows how those Voltages are Distributed over the complete PowerWafer. All white Reticles are not measurable, and those colored in Red and Yellow are the outliers in Figure 3.14. Note that in a deployed, working, Wafer System inside BrainScaleS the middle two Reticles (19 & 28) are not used and also give grounds to ignoring the outliers.

This results in a distribution, which when combined with the spread of  $R_0$  from Figure 3.12, gives an approximate range for all Reticles Voltage Dip at a given Current Draw (Figure 3.16).

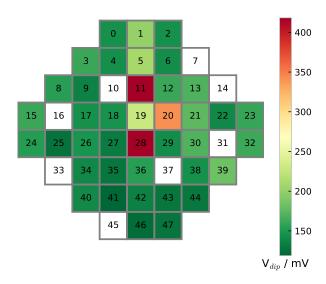


Figure 3.15:  $V_{dip}$  Distribution over full Power Wafer; White have no measurement; Red an Orange are marked red in Figure 3.14

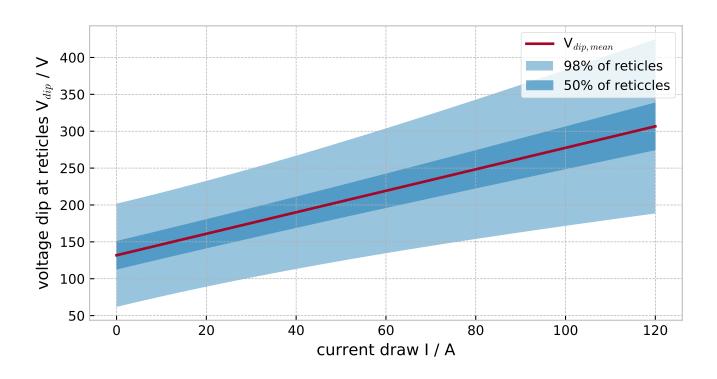


Figure 3.16: Experimentally obtained Voltage Ranges in which most Reticles Voltage Dip will lie, this does not include outliers

## 3.4 Pitfalls

## 4 Results

This Chapter summaizes all of the resulting Workflow that has been developed during this Bachelor Thesis Work. Mainly the Firmware Changes compared to the state at wich it was left off after the previously taken Internship [3]

#### 4.1 Firmware

The Powerlt Firmware was updated to allow for the Calibration Procedure (described in 4.2) and the Rgulation of its 1.8V output. That resulted in a new Version of the I2C Protocol between the Monitoring System and Powerlts.

#### 4.1.1 PI2CProto v2

The new Commmunication protocoll is based on the old one, and while the from the Host send Commands are compatible with version 1 the returned Message is not. And just like in the old Version a Master can send a message to the Powerlt with the in the command\_t struct described structure:

Here the <CMD> can be CMD\_SET for setting a value in the corresponding table (fig. 4.1), using <optional\_data0> as address and <optional\_data1> as value.

Reading a number of bytes from the table can be accomplished with CMD\_READ, giving the address to start and number of bytes in that order.

While reading the complete Table is done with the CMD\_READALL command.

THe <crc> byte is the CRC8 value of all following bytes inside command\_t

#### 4.1.2 I2C mapped Register-Table

When sending or reading values to or from the Powerlt, the address required is one of the 152 bytes documented in this table.

addr	name	type	size	perm
0x00	onmask	byte	1	rw
0×01	offmask	byte	1	rw
0×02	anapot	9bit	2	rw
0×04	digipot	9bit	2	rw
0x06	polyFit.V48	float arr	12	rw
0x12	polyFit.I48	float arr	12	rw
0x1e	polyFit.V8	float arr	12	rw
0x2a	polyFit.V18	float arr	12	rw
0x36	polyFit.I18	float arr	12	rw
0x42	polyFit.T	float arr	12	rw
0x4e	sampleTicks	byte	1	rw
0x4f	V_out	float	4	rw
0x53	TEMP_SENSOR	float	4	r
0x57	EXT_AIN	float	4	r
0x5b	MONITOR_48V	float	4	r
0x5f	MONITOR_48I	float	4	r
0x63	MONITOR_8VBUS	float	4	r
0×67	MONITOR_8IBUS	float	4	r
0x6b	MONITOR_8V_0	float	4	r
0x6f	MONITOR_8V_1	float	4	r
0x73	MONITOR_8V_2	float	4	r
0x77	MONITOR_8V_3	float	4	r
0x7b	VDD_1V8_ANA	float	4	r
0x7f	VDD_1V8_IOUT_ANA	float	4	r
0x83	VDD_1V8_DIGI	float	4	r
0x87	VDD_1V8_IOUT_DIGI	float	4	r
0x8b	CommitHash	float	4	S
0x8f	CommitDirtyFlag	byte	1	S
0×90	STM32UUID	96bit	12	S

Figure 4.1: memory mapping of the packed struct moved over i2c, addr is the address to use, type is the c++ type, size is in bytes and perm denotes read-writability. writability

#### 4.2 Calibration

One of the goals of this Bachelor Thesis is to provide anyone required to calibrate a Powerlt Board with a comprehensive guide of, and inside into this process.

#### 4.2.1 Calibration-Table

Of important note is that al calibration values of each PowerIt can be mapped via the naming and uuid scheme provided either by the corresponding stickers or the STM32-Chips internal uuid (accessible through address 0x8c, see figure 4.1). There now also exists a global calibration Database, which will be loaded by the system on startup.

An example entry for each PowerIt entry looks like figure 4.2

```
id: '0x280029000F51333332343638'
name: B05
poly18iana: [-31.5155, 78.516, -0.0688]
poly18idigi: [-31.3536, 78.3701, -0.196]
poly18i: [-31.4396, 78.443, -0.1324]
poly48i: [-0.1765, 153.0021, -204.1858]
poly10v: [0.6348, 3.459, 0.1118]
poly48v: [-4.5248, 33.3195, -1.6167]
poly18v: [0.0234, 0.9728, 0.0072]
```

```
Figure 4.2: example entry of pitdb.yaml

---

uuid: 'default'
name: 'Bxx'

poly18i: [-3.0, 25.0, 0.0]

poly48i: [0.0, 227.27, 0.0]

poly10v: [0.0, 4.0, 0.0]

poly18v: [0.0, 1.0, 0.0]

poly48v: [0.0, 27.386, 0.0]
```

#### 4.2.2 How to calibrate a Powerlt Board

The Calibration process is based on the PItSTOP Python scripts<sup>1</sup>. These are split into server and aggregator. While the Server is handling the translation between raw I<sup>2</sup>C data, and the JSON formatted result, the Aggregator takes this JSON and calculates a calibration.

Using the script any one of the following Values can be tested and calibrated:

- Input Voltage (pitstop.Aggregator.test\_v\_48())
- Input Current (pitstop.Aggregator.test\_i\_48())
- 9.6V Output Voltage (pitstop.Aggregator.test\_v\_10())
- 1.8V Output Voltage (pitstop.Aggregator.test\_v\_18())
- 1.8V Output Current (pitstop.Aggregator.test\_i\_18())

#### Setting up the Test Environment

The simplest way to setup your environment consists of cloning the PItSTOP Project onto your Client:

```
> git clone https://url.to.pitstop
```

<sup>&</sup>lt;sup>1</sup> PltSTOP Repo

then substituting the rsync target:

```
all:
rsync --progress ./*.py /remote.url/
```

, to be your server (should be a RaspberyyPi connected to the PowerIt)

#### Running a Test

Runnig the test requires the following commands Serverside:

```
> python server.py
```

#### Clientside:

```
> python aggregator.py
```

Now just following the instructions given, the selected test can be run:

## 4.3 Regulation

## 4.3.1 Distance Wafer Resistance Model (DWRM)

Although the through SWRM gained functions approximate the real world, it is not exact enough. In a wafer, the distance between reticles and voltage connector (see Figure 2.8) are resulting in additional resistance.

Therefore we adapt the DWRM after Circuit 4.3 in which each different Distance requires additional Resistors.

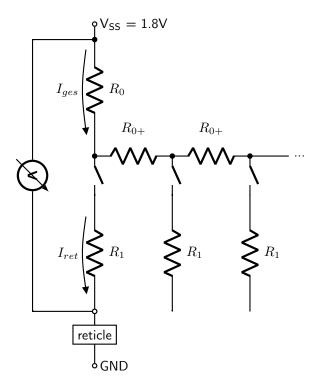


Figure 4.3: Modified model of the to measure resistances and their currents. Similar to SWRM  $R_0$  describes the resistance of a connection between the Powerlt Output, up to the FET (depicted as switch), while  $R_1$  is a Resistance between FET and Reticles. But additionally  $R_{0+}$  described a Resistance, that depends on the distance between reticle and voltage connector. The measurement is done between output terminals on the Powerlt and pins on a Analog readout board

With this model the voltage is now expected to change depending on the reticles distance instead of being the same. The distances inside a wafer are visualized in Figure 4.4

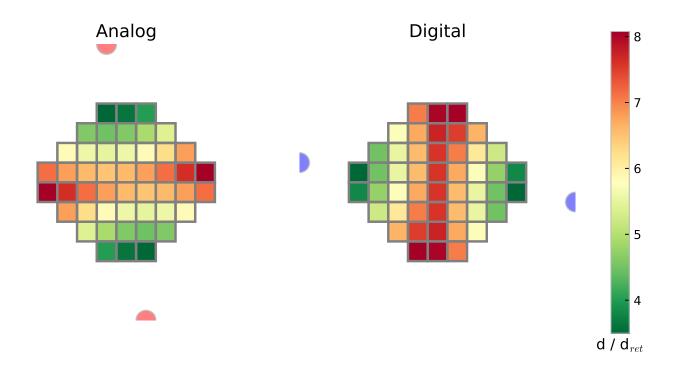


Figure 4.4: Distances of reticles to the nearest voltage supplying connection for DWRM, distance is in reticle-side length

# 5 Outlook

# **Bibliography**

- [1] A. P. Davison, E. Müller, et al., HBP Neuromorphic Computing Platform Guidebook. Human Brain Project, 2015-2018. EV Guide .
- [2] A. P. Davison, E. Müller, et al., HBP Neuromorphic Computing Platform Guide-book BrainScaleS Hardware Configuration. Human Brain Project, 2015-2018. https://electronicvisions.github.io/hbp-sp9-guidebook/pm/pm\_hardware\_configuration.html.
- [3] P. Nisble, "Firmware upgrade des powerit (de)," 2018. .
- [4] STMicroelectronics, *STM32F405xx Datasheet (DM00037051)*. STMicroelectronics, 2016. STM32F405RG.
- [5] G. di Sirio. ChibiOS RTOS [accessed 2018/01/11].
- [6] TexasInstruments, AMC1200/B Fully-Differential Isolation Amplifier, 2015.
- [7] Microchip Technology, SPI Digital POT with Volatile Memory, 2008.
- [8] Texas Instruments, PTH08T250W Datasheet, 2017.
- [9] D. Husman, Analog Pin Distributions. electronic visions, University of Heidelberg, 2016.

# Statement of Originality (Erklärung)

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Ich versichere, dass ich diese Arbeit selbstständig verfasst und keine anderen als die angegebener Quellen und Hilfsmittel benutzt habe.
Heidelberg, 29. August 2018,
(signature)